

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Akira Matsuzawa</td> <td>07/26/2012</td> </tr> <tr> <td>Masaya MIYAHARA</td> <td>07/26/2012</td> </tr> </tbody> </table>		Name	Execution Date	Akira Matsuzawa	07/26/2012	Masaya MIYAHARA	07/26/2012
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Akira Matsuzawa	07/26/2012						
Masaya MIYAHARA	07/26/2012						
RECEIVING PARTY DATA							
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Postal Code:	152-8550						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13593868</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13593868		
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Application Number:	13593868						
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Total Attachments: 2 source=6EB2115#page1.tif source=6EB2115#page2.tif							

OP \$40.00 13593868

ASSIGNMENT

WHEREAS We, Akira Matsuzawa of c/o Tokyo Institute of Technology, 2-12-1 Ookayama, Meguro-ku, Tokyo 152-8550 Japan and Masaya Miyahara of c/o Tokyo Institute of Technology, 2-12-1 Ookayama, Meguro-ku, Tokyo 152-8550 Japan (hereinafter referred to as "ASSIGNORS") have invented certain new and useful improvements in:

PIPELINE A/D CONVERTER AND A/D CONVERTING METHOD

for which We are about to file or have filed an application for Letters Patent of the United States;

AND WHEREAS, Tokyo Institute of Technology (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Japan, having a place of business at 2-12-1 Ookayama, Meguro-ku, Tokyo 152-8550 Japan, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of

Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: July 26, 2012

Akira Matsuzawa L.S.
Akira Matsuzawa

Date: July 26, 2012

Masaya Miyahara L.S.
Masaya Miyahara